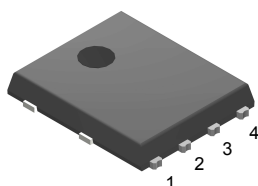
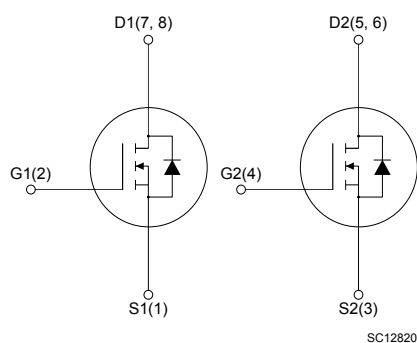


Automotive-grade dual N-channel 60 V, 21 mΩ typ., 32 A STripFET F6 Power MOSFET in a PowerFLAT 5x6 DI package



**PowerFLAT 5x6
double island**



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	P _{TOT}
STL8DN6LF6AG	60 V	27 mΩ	32 A	55 W

- AEC-Q101 qualified 
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss
- Wettable flank package

Applications

- Switching applications

Description

This device is a dual N-channel Power MOSFET developed using the STripFET F6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low R_{DS(on)} in all packages.



Product status link

[STL8DN6LF6AG](#)

Product summary

Order code	STL8DN6LF6AG
Marking	8DN6LF6
Package	PowerFLAT 5x6 double island
Packing	Tape and reel

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	60	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current (continuous) at $T_C = 25\text{ }^{\circ}\text{C}$	32	A
	Drain current (continuous) at $T_C = 100\text{ }^{\circ}\text{C}$	23	
$I_D^{(1)}$	Drain current (continuous) at $T_B = 25\text{ }^{\circ}\text{C}$	9.6	A
	Drain current (continuous) at $T_B = 100\text{ }^{\circ}\text{C}$	6.8	
$I_{DM}^{(1)(2)}$	Drain current (pulsed)	38	A
$I_{DM}^{(2)}$	Drain current (pulsed)	128	A
P_{TOT}	Total dissipation at $T_C = 25\text{ }^{\circ}\text{C}$ (one channel active)	55	W
	Total power dissipation at $T_B = 25\text{ }^{\circ}\text{C}$ (one channel active)	4.8	
T_{stg}	Storage temperature range	-55 to 175	$^{\circ}\text{C}$
T_J	Operating junction temperature range		$^{\circ}\text{C}$

1. When mounted on a 1-inch² FR-4, 2 Oz copper board, $t < 10\text{ s}$.
2. Pulse width is limited by safe operating area.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance, junction-to-case	2.7	$^{\circ}\text{C/W}$
$R_{thJB}^{(1)}$	Thermal resistance, junction-to-board	31.3	

1. When mounted on a 1-inch² FR-4, 2 Oz copper board, $t < 10\text{ s}$.

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I_{AV}	Avalanche current, not repetitive	32	A
E_{AS}	Single pulse avalanche energy (starting $T_J = 25\text{ }^{\circ}\text{C}$, $I_D = 38\text{ A}$, $V_{DD} = 43.5\text{ V}$)	120	mJ

2 Electrical characteristics

$T_C = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$	60			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$, $V_{DS} = 60\text{ V}$			1	μA
I_{GSS}	Gate-body leakage current	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 20\text{ V}$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	1		2.5	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10\text{ V}$, $I_D = 9.6\text{ A}$		21	27	m Ω
		$V_{GS} = 4.5\text{ V}$, $I_D = 9.6\text{ A}$		25	31	

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0\text{ V}$	-	1340	-	pF
C_{oss}	Output capacitance		-	90	-	pF
C_{rss}	Reverse transfer capacitance		-	60	-	pF
Q_g	Total gate charge	$V_{DD} = 30\text{ V}$, $I_D = 9.6\text{ A}$, $V_{GS} = 10\text{ V}$ (see Figure 13. Test circuit for gate charge behavior)	-	27	-	nC
Q_{gs}	Gate-source charge		-	4.6	-	nC
Q_{gd}	Gate-drain charge		-	4.3	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 30\text{ V}$, $I_D = 12.5\text{ A}$, $R_G = 4.7\text{ }\Omega$, $V_{GS} = 10\text{ V}$	-	9.6	-	ns
t_r	Rise time		-	20	-	ns
$t_{d(off)}$	Turn-off delay time	(see Figure 12. Test circuit for resistive load switching times and Figure 17. Switching time waveform)	-	56	-	ns
t_f	Fall time		-	7	-	ns

Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		9.6	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		38	A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0\text{ V}$, $I_{SD} = 9.6\text{ A}$	-		1.3	V
t_{rr}	Reverse recovery time	$I_{SD} = 25\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$, $V_{DD} = 48\text{ V}$, $T_J = 25\text{ }^\circ\text{C}$ (see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	22.5		ns
Q_{rr}	Reverse recovery charge		-	22.2		nC
I_{RRM}	Reverse recovery current		-	2.0		A

1. Pulse width is limited by safe operating area.
2. Pulse test: pulse duration = 300 μs , duty cycle 1.5%.

2.1 Electrical characteristics (curves)

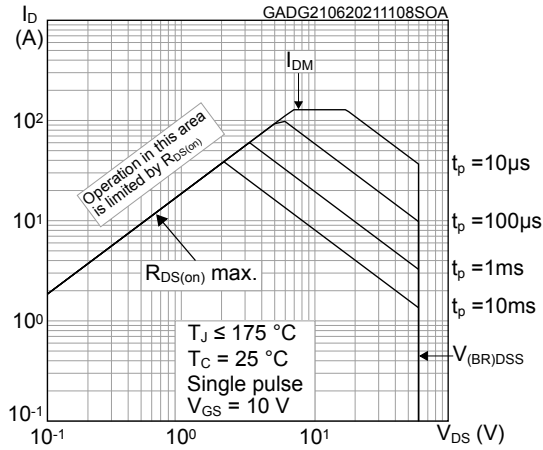
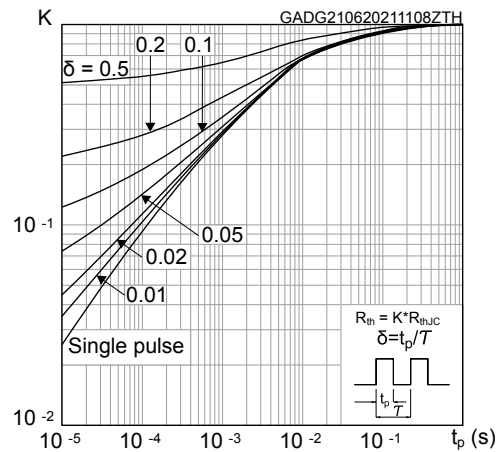
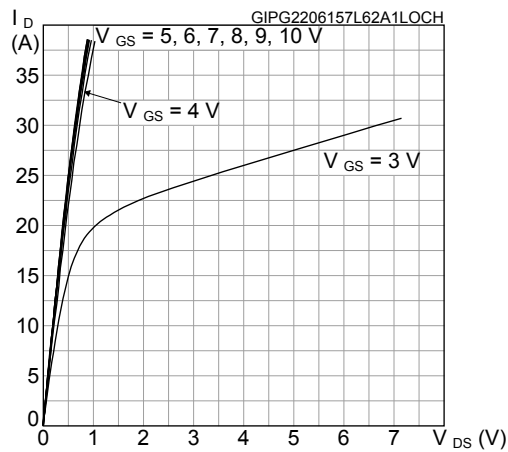
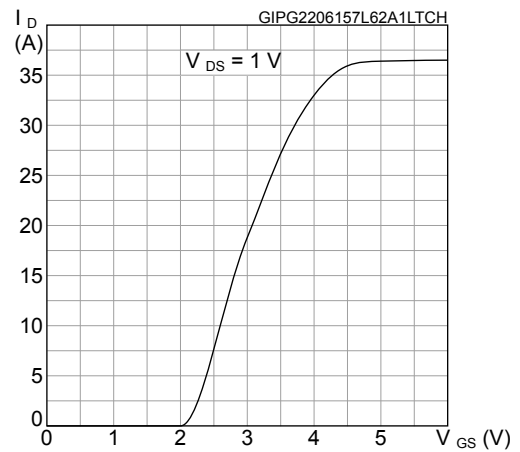
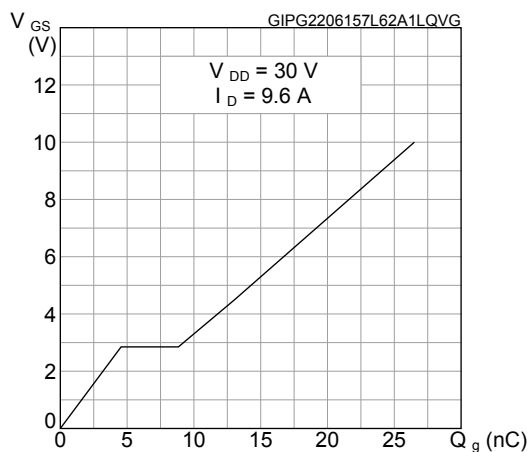
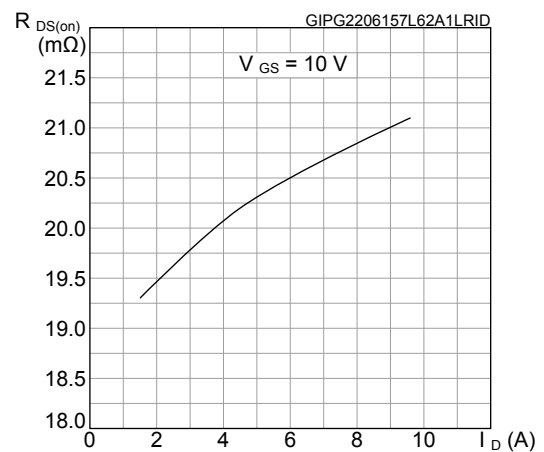
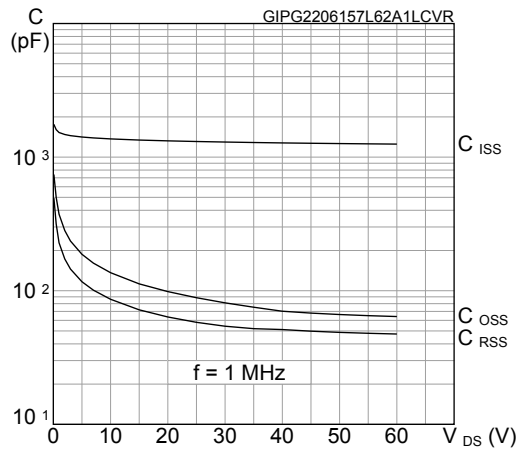
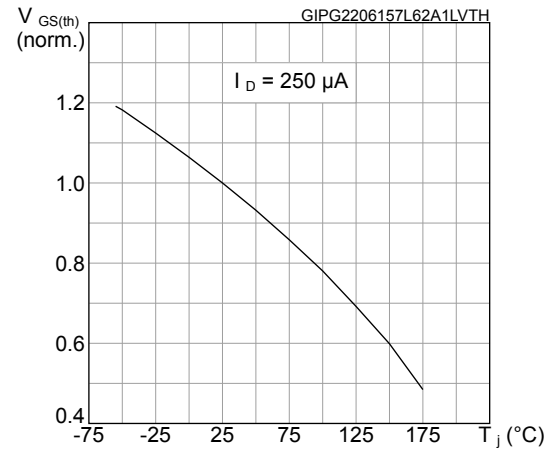
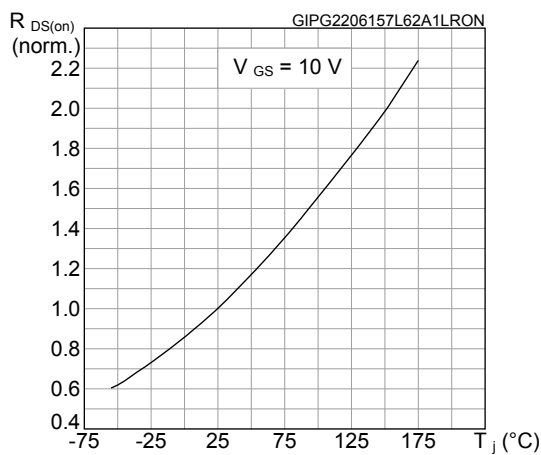
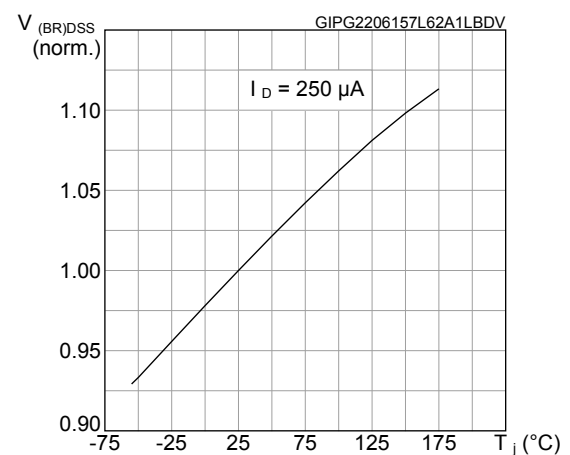
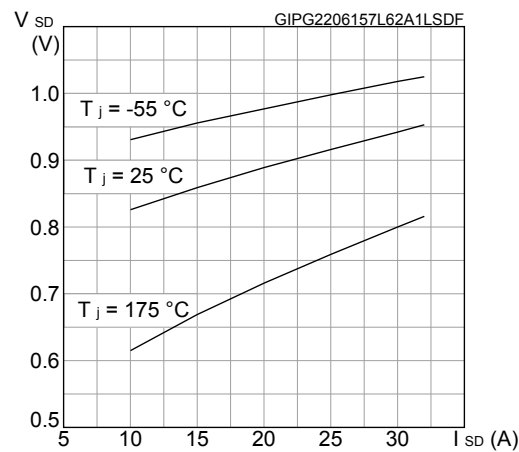
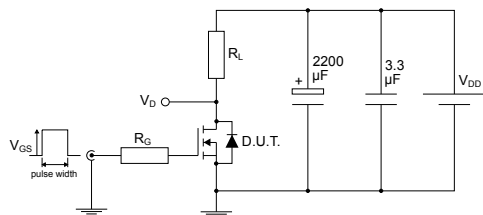
Figure 1. Safe operating area

Figure 2. Thermal impedance

Figure 3. Output characteristics

Figure 4. Transfer characteristics

Figure 5. Gate charge vs gate-source voltage

Figure 6. Static drain-source on-resistance


Figure 7. Capacitance variations

Figure 8. Normalized gate threshold voltage vs temperature

Figure 9. Normalized on-resistance vs temperature

Figure 10. Normalized V_(BR)DSS vs temperature

Figure 11. Source-drain diode forward characteristics


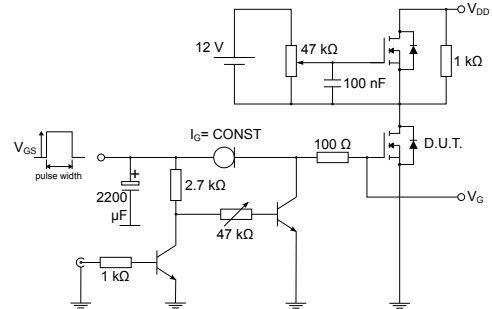
3 Test circuits

Figure 12. Test circuit for resistive load switching times



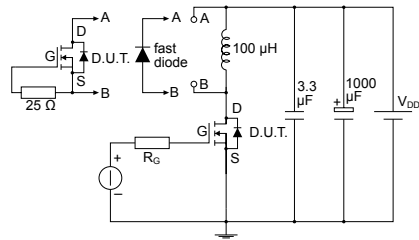
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Figure 13. Test circuit for gate charge behavior



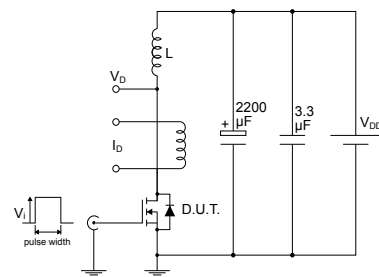
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Figure 14. Test circuit for inductive load switching and diode recovery times



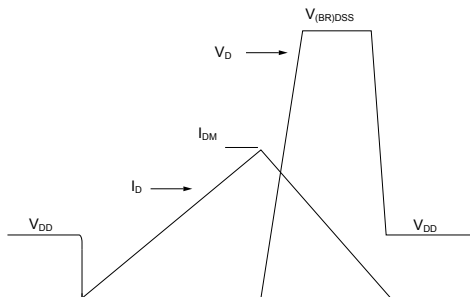
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Figure 15. Unclamped inductive load test circuit



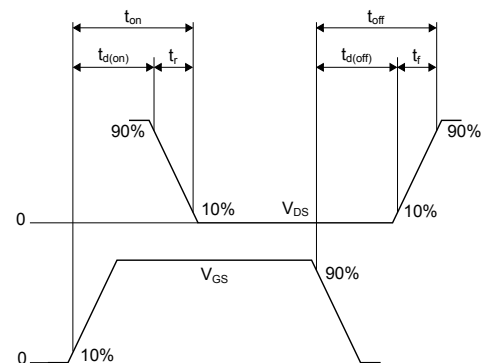
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Figure 16. Unclamped inductive waveform



AM01472v1

Figure 17. Switching time waveform



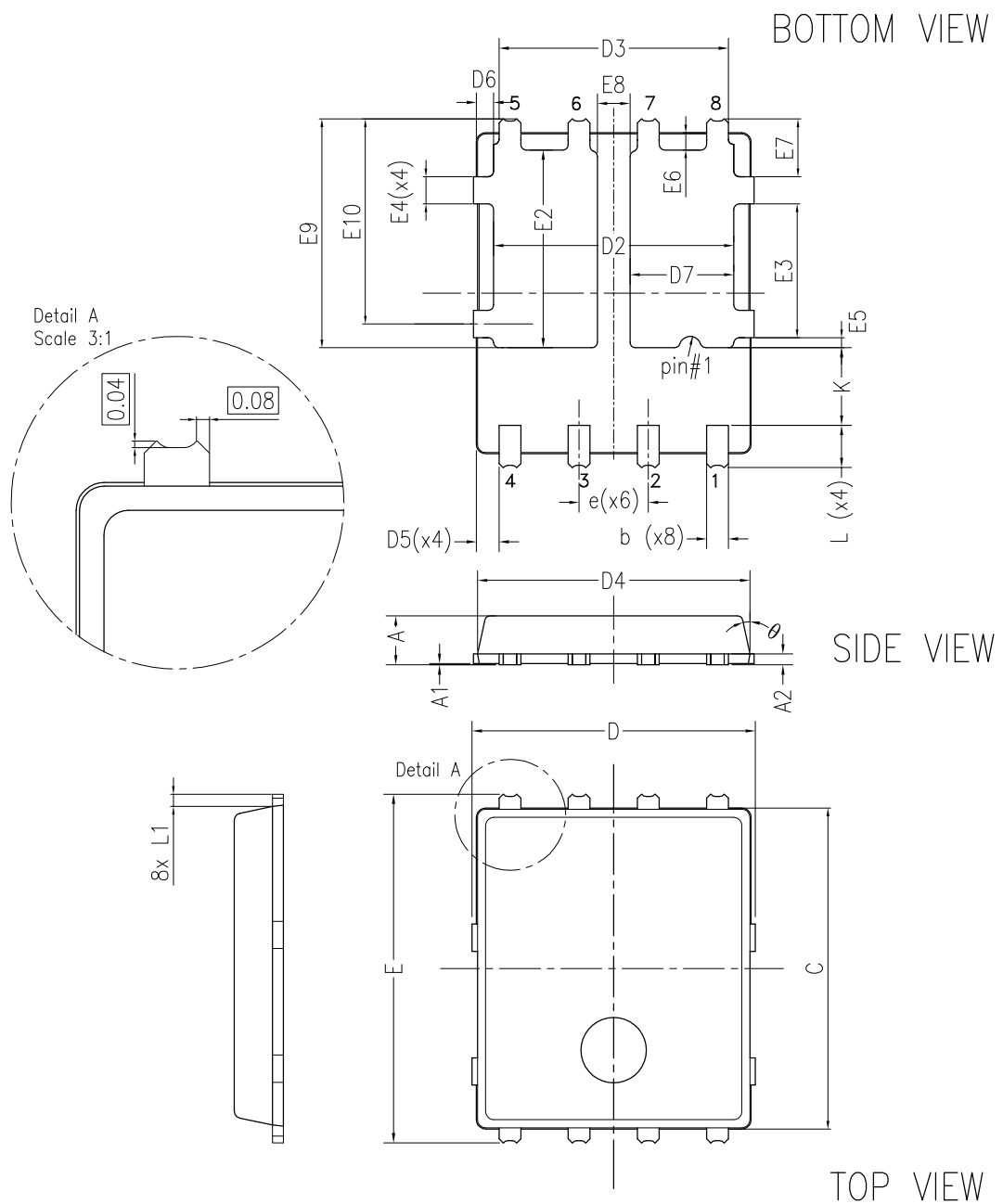
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 PowerFLAT 5x6 double island WF type R package information

Figure 18. PowerFLAT 5x6 double island WF type R package outline

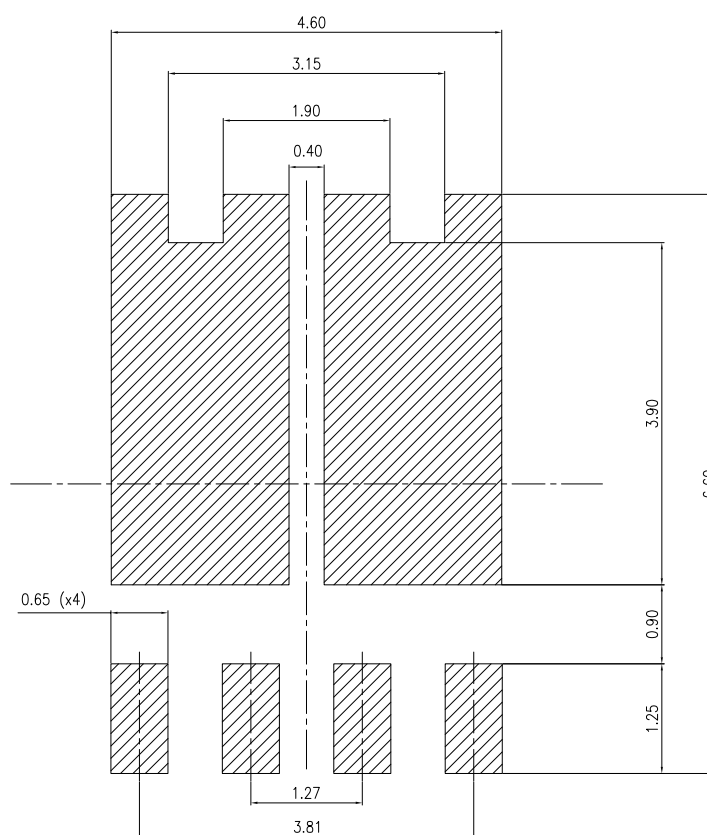


8256945_typeR-WF_R18

Table 8. PowerFLAT 5x6 double island WF type R mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
C	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
D7	1.68		1.98
e		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E8	0.55		0.75
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
K	1.275		1.575
L	0.725	0.825	0.925
L1	0.175	0.275	0.375
θ	0°		12°

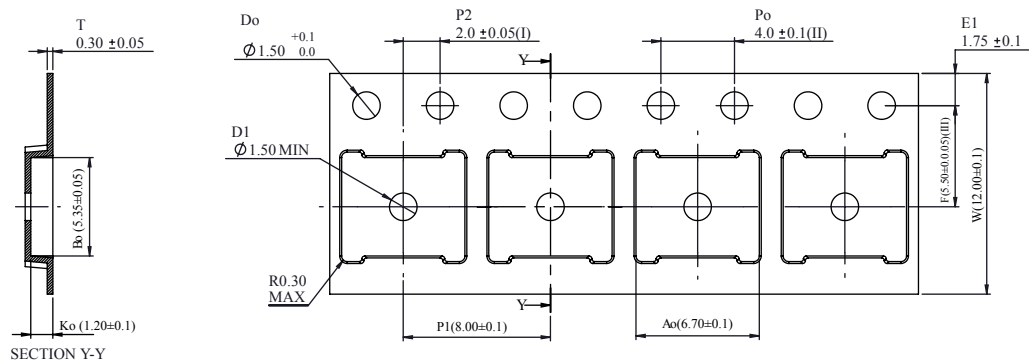
Figure 19. PowerFLAT 5x6 double island recommended footprint (dimensions are in mm)



8256945_DI_FP_smp_R18

4.2 PowerFLAT 5x6 WF packing information

Figure 20. PowerFLAT 5x6 WF tape (dimensions are in mm)



- (I) Measured from centreline of sprocket hole to centreline of pocket.
- (II) Cumulative tolerance of 10 sprocket holes is ± 0.20 .
- (III) Measured from centreline of sprocket hole to centreline of pocket.

Base and bulk quantity 3000 pcs

8234350_TapeWF_rev_C

Figure 21. PowerFLAT 5x6 package orientation in carrier tape

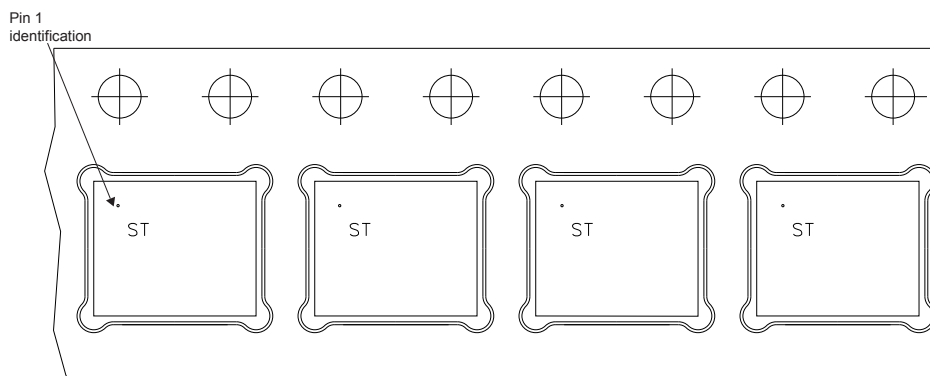
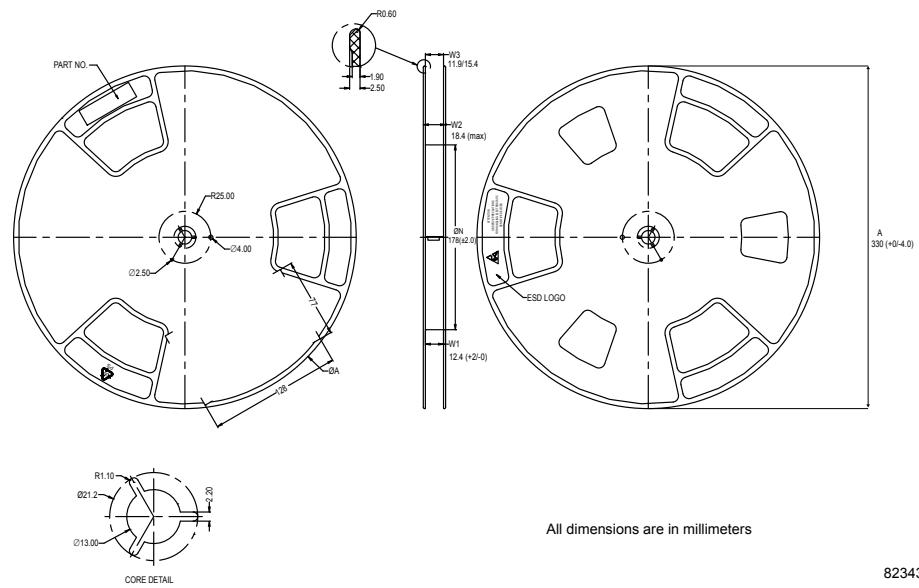


Figure 22. PowerFLAT 5x6 reel (dimensions are in mm)



Revision history

Table 9. Document revision history

Date	Revision	Changes
24-Jun-2015	1	First release.
07-Jul-2015	2	Minor text edits throughout document.
19-Jan-2016	3	Updated title. Updated <i>Table 2: "Absolute maximum ratings"</i> , <i>Table 3: "Thermal data"</i> and <i>Table 4: "Avalanche characteristics"</i> . Updated <i>Figure 2: "Safe operating area"</i> and <i>Figure 3: "Thermal impedance"</i> . Minor text changes.
21-Sep-2016	4	Updated <i>Table 2: "Absolute maximum ratings"</i> . Updated <i>Section 4.1: "PowerFLAT™ 5x6 double island WF type R package information"</i> . Minor text changes.
01-Jul-2021	5	Updated Internal schematic for dual N-channel in cover page. Updated Figure 1. Safe operating area and Figure 2. Thermal impedance . Minor text changes.

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	Revision history	13

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